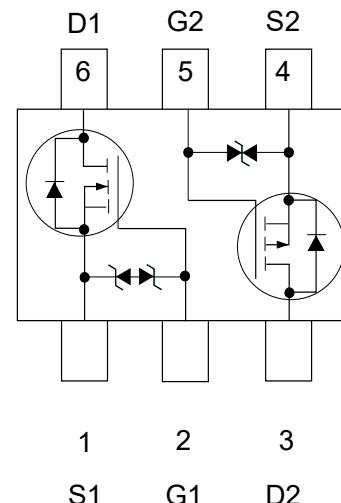


## Description

The enhancement mode MOS is extremely high density cell and low on-resistance.

MOSFET Product Summary		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
N-Channel 20	0.3@ V <sub>GS</sub> =4.0V	0.6
	0.45@ V <sub>GS</sub> =2.5V	
	0.6@ V <sub>GS</sub> =1.8V	
P-Channel -20	0.9@ V <sub>GS</sub> =-4.5V	-0.8
	1.2@ V <sub>GS</sub> =-2.5V	
	1.5@ V <sub>GS</sub> =-1.8V	



## N-Channel

### Absolute maximum rating@25°C

Rating		Symbol	Value	Units
Drain-Source Voltage		V <sub>DS</sub>	20	V
Gate-Source Voltage		V <sub>GS</sub>	±8	V
Drain Current	Continuous	I <sub>D</sub>	0.6	A
	Pulsed	I <sub>D</sub>	3.0	A
Total Power Dissipation	T <sub>A</sub> =25°C	P <sub>D</sub>	170	mW
	T <sub>A</sub> =125°C	P <sub>D</sub>	155	mW

## Electrical characteristics per line@25°C( unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D = 250\mu A, V_{GS} = 0V$	20		-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20V, V_{GS} = 0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 8V$	-	-	$\pm 1$	$\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.5		1.1	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 4.0V, I_D = 300mA$	-	0.3	0.5	$\Omega$
		$V_{GS} = 2.5V, I_D = 200mA$	-	0.45	0.7	$\Omega$
		$V_{GS} = 1.8V, I_D = 150mA$		0.6	0.9	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 16V, f = 1MHz$	-	135		pF
Output Capacitance	$C_{dss}$		-	23		pF
Reverse Transfer Capacitance	$C_{rss}$		-	18		pF
<b>SWITCHING PARAMETERS</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DS} = 10V, V_{GS} = 4.5V, R_G = 10\Omega, I_D = 0.2A$	-		15	ns
Turn-Off Delay Time	$t_{d(off)}$		-		55	ns

## P-Channel

## Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	$V_{GS}$	$\pm 8$	V
Drain Current	Continuous	$I_D$	A
	Pulsed	$I_D$	A
Total Power Dissipation	$T_A = 25^\circ C$	$P_D$	mW
	$T_A = 125^\circ C$	$P_D$	mW

## Electrical characteristics per line@25°C( unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D = -250\mu A, V_{GS} = 0V$	-20	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 20V, V_{GS} = 0V$	-	-	-1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 8V$	-	-	$\pm 1$	$\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-0.5		-1.1	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -200mA$	-	0.9	1.2	$\Omega$
		$V_{GS} = -2.5V, I_D = -100mA$	-	1.2	1.5	$\Omega$
		$V_{GS} = -1.8V, I_D = -100mA$		1.5	2.2	$\Omega$
Forward Transistor conductance	$g_{FS}$	$V_{GS} = 5V, I_D = 50mA, T_A = 125^\circ C$		6.5		S
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{ISS}$	$V_{GS} = 0V, V_{DS} = -6V, f = 200\text{KMHz}$	-	200		pF
Output Capacitance	$C_{DSS}$		-	80		pF
Reverse Transfer Capacitance	$C_{RSS}$		-	150		pF
<b>SWITCHING PARAMETERS</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -6V, V_{GS} = -4.5V, R_L = 6\Omega, R_G = 6\Omega, I_D = -1A$	-		17	ns
Turn-Off Delay Time	$t_{d(off)}$		-		65	ns

## N-Channel

## Typical Characteristics

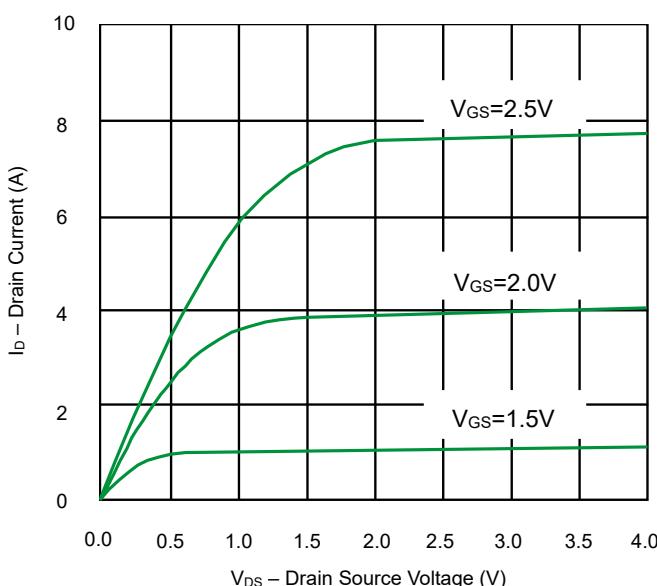


Fig 1. Output Characteristics

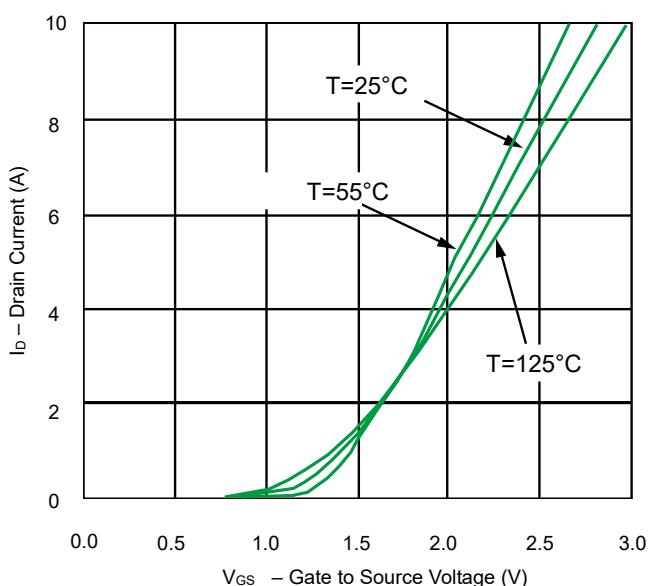


Fig 2. Transfer Characteristics

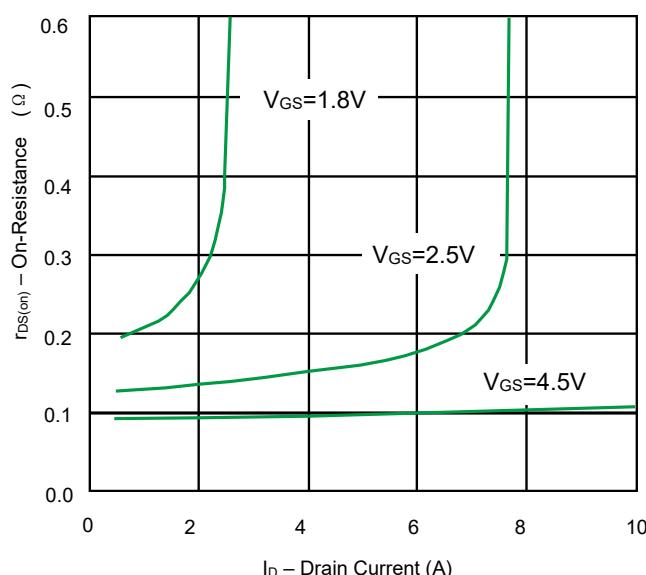


Fig 3. On-Resistance vs. Drain Current

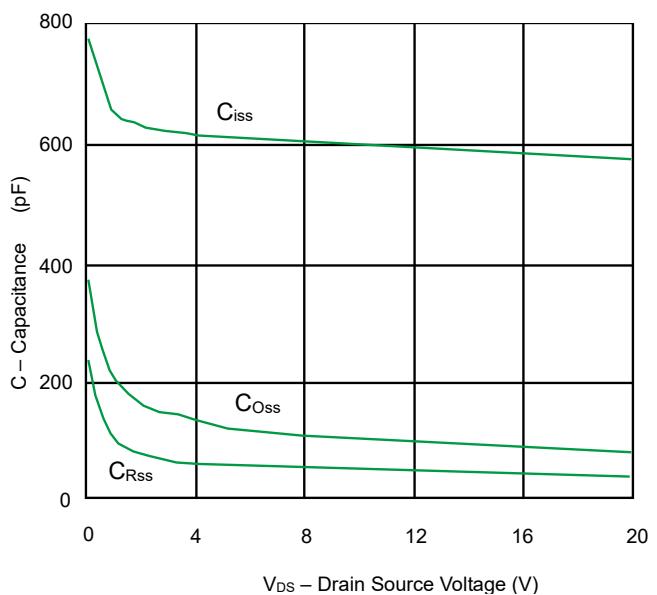


Fig 4. Capacitance

## P-Channel

### Typical Characteristics

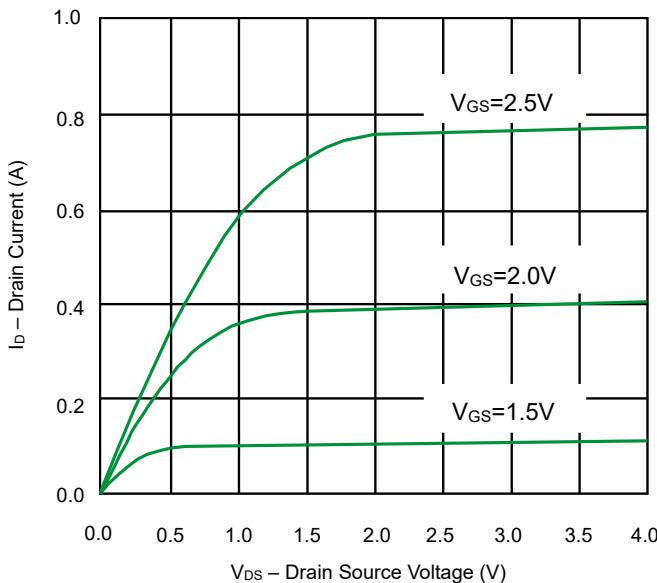


Fig 1. Output Characteristics

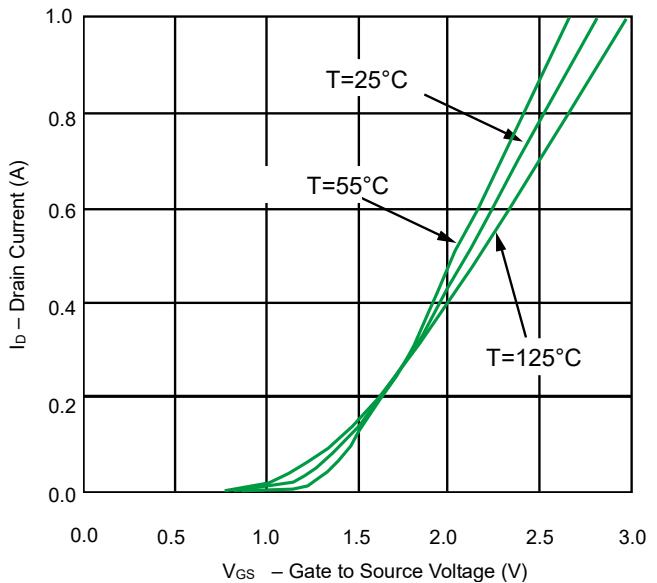


Fig 2. Transfer Characteristics

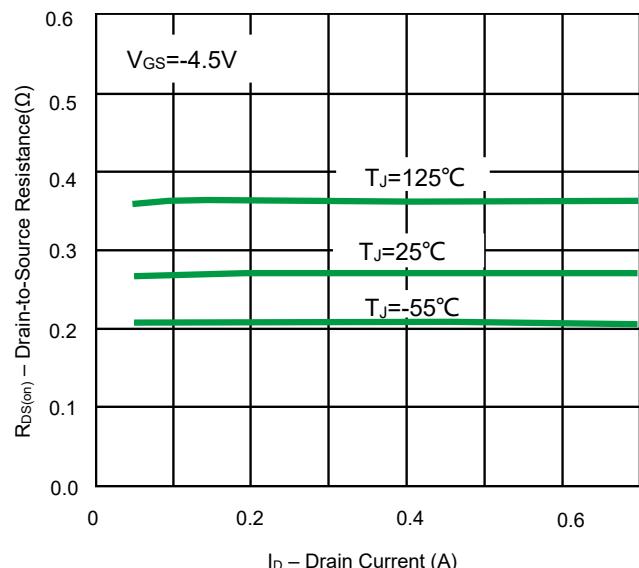


Fig 3. On-Resistance vs. Drain Current

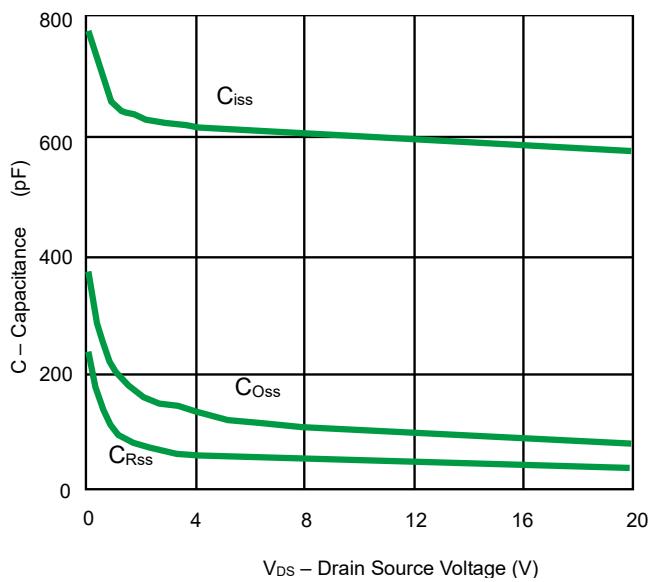
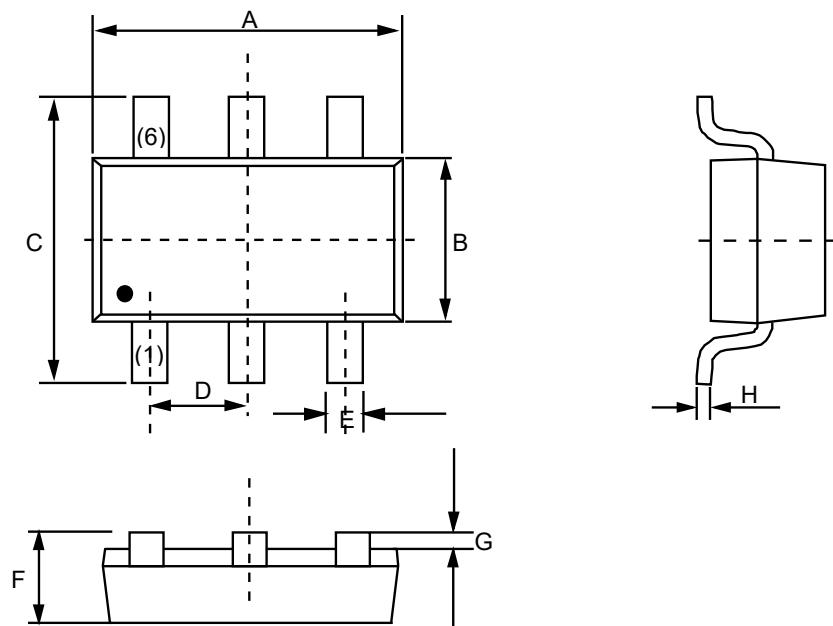


Fig 4. Capacitance

### Product dimension (SOT-363)



Dim	Millimeters		Inches	
	MIN	MAX	MIN	MAX
A	2.0	2.2	0.079	0.087
B	1.15	1.35	0.045	0.053
C	2.15	2.45	0.085	0.096
D	0.65BSC		0.026BSC	
E	0.15	0.35	0.006	0.014
F	0.90	1.10	0.035	0.043
G	0.00	0.10	0.000	0.004
H	0.08	0.15	0.003	0.006

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